

1. 55 μm 波長帯単一光子源用サブミクロン直径 Si/SiO₂-InP 微小共振器 Hybrid SiO₂/Si-InP micropillar cavity with submicrometer diameter for single-photon sources in 1.55- μm -wavelength telecommunication band

東大ナノ量子機構¹, 富士通研究所², 東大生産研³

○宋海智¹, 竹本一矢¹, 宮澤俊之², 高津求¹, 岩本敏^{1,3}, 江川満², 山本剛之², 荒川泰彦^{1,3}

NanoQuine, Univ. of Tokyo¹, Fujitsu Labs.², IIS, Univ. of Tokyo³

○H. Z. Song¹, K. Takemoto¹, T. Miyazawa², M. Takatsu¹, S. Iwamoto^{1,3}, M. Ekawa², T. Yamamoto², Y. Arakawa^{1,3}

E-mail: hzsong@iis.u-tokyo.ac.jp

Solid state microcavities are powerful in producing high efficiency light-emitting diodes, low-threshold lasers and single-photon sources. Quantum key distribution over 50 km has been successful with 1.55- μm InAs/InP quantum dot (QD) single photon sources (SPSs) [1]. Its further development for higher speed, photon-indistinguishability demands for implementing QD-SPSs in microcavities. Recently, we have proposed an effective micropillar cavity with the Purcell factor over 20 consisting of Si/SiO₂ distributed Bragg reflectors (DBRs) and an InP spacer [2]. However, this cavity has a diameter as large as $\sim 2 \mu\text{m}$ so that resonance with a single QD imposes the strict requirement for the dot density. For the wavelength below 1 μm , recent studies show that the design of tapered DBRs can obtain high Q factors ($>10^4$) in GaAs/AlAs and TiO₂/SiO₂ micropillar cavities with sub-micrometer diameters [3]. We herewith apply the tapered DBRs to our hybrid micropillar cavity for 1.55- μm wavelength and numerically study its optical performance in sub-micrometer region.

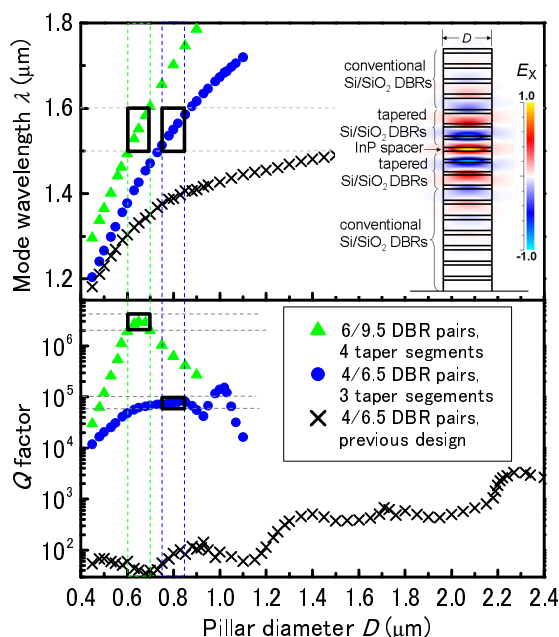


Fig.1. The mode wavelength and Q factor of the tapered and previous cavities as functions of pillar diameter. The inset shows the schematic cross section of the tapered cavity, together with a representative mode profile.

As shown schematically in the inset of Fig. 1, there inserted tapered Si/SiO₂ DBRs in between the conventional Si/SiO₂ DBRs (each layer $\lambda/4$ thick) and an InP spacer, both of which also existed in our previous design. In the tapered DBRs, the Si and SiO₂ layers adiabatically get thinner as they come close to the spacer. Using finite-difference-time-domain analysis, the fundamental mode of such a cavity is resolved. The mode profile is found, as expected, well confined horizontally within the pillar and vertically within the tapered DBRs. The Q factor for wavelength around 1.55 μm is found greatly improved with respect to our previous cavities while the pillar diameter D is decreased to be less than 1 μm , as shown in Fig. 1. Focusing on the mostly interested wavelength range $\lambda=1.55\pm0.05 \mu\text{m}$, a structure with 4/6.5 DBRs and 3 taper segments gives $Q\sim 8\times 10^4$ as $D=0.75\text{--}0.85 \mu\text{m}$, and a structure with 6/9.5 DBR pairs and 4 taper segments gives $Q\sim 3\times 10^6$ as $D=0.60\text{--}0.70 \mu\text{m}$. The obtained Q factors are at least two orders of magnitude higher than the previous (*i.e.* non-tapered) micropillar cavity [2] comparing at the same pillar diameters. Moreover, the Q factors also exceed the highest performance ($Q\sim 3\times 10^3$) reported in the previous result for the optimum diameter ($D\sim 2.3 \mu\text{m}$).

Taking into account the typical parameters of InAs/InP QDs [1,2] and the mode volume of $V\sim 0.8(\lambda/n)^3$, we can conclude that our hybrid cavity with tapered DBRs has a potential to realize a gigahertz-clock SPS at 1.55 μm for well isolated single QD by enhancing the spontaneous emission rate with a Purcell factor of over 100. The tapered hybrid Si/SiO₂-InP micropillar cavity is thus promising for realizing high-speed quantum communication network based on QD-SPSs.

This work was supported by Project for Developing Innovation Systems of the Ministry of Education, Culture, Sports, Science and Technology (MEXT), Japan.

[1]K. Takemoto *et al.*, Appl. Phys. Exp. **3**, 092802 (2010).

[2]宋他、応用物理学会 2013 春季学術講演会, 29a-PB6-1; Song *et al.* Opt. Lett. **38**, 3241(2013).

[3]M. Lerner *et al.* Phys. Rev. Lett. **108**, 057402 (2012); Y. Zhang *et al.*, Opt. Lett. **34**, 902 (2009).